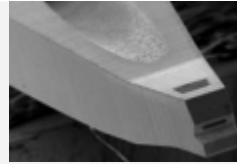




The Box Style Wedge (Automatic)
Best suited for Automatic and Semi-Automatic wire bond equipment.



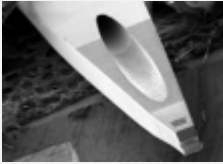
Ribbon Bonding Tools
A wide range of Ribbon Bonding tool solutions for both manual and automatic bonding equipment.



The Notch Style Wedge (Manual)
Primarily designed for use on Manual wire bonders. The best choice for Manual wire bonders and is especially useful for our Microwave customers.



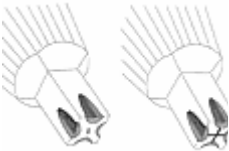
TAB bonding
Available to cover all TAB applications. TAB tool applications include: Insulated wire bonding, Ribbon mesh bonding, Micro BGA bonding, Tamping, and Lead Beam bonding.



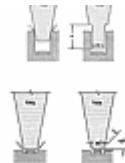
Vertical Feed / Deep Access Tools
A wide range of Vertical Feed / Deep Access bonding tool solutions for both manual and automatic bonding equipment.



Insulated Wire Bonding Tools
Insulated Wire Bonding tool solutions for various size wire. There are three material choices for your consideration, Tungsten Carbide, Titanium and Ceramic.



Micro-BGA Tools (Tessera®)
A wide range of Micro-BGA/Tessera bonding tool solutions. We offer a minimum of three material choices for your consideration, Tungsten Carbide, Titanium and Ceramic.



Tool Options
DeWeyl Tool offers customer bonding tools solutions to address the problems of today's complex package designs. Please contact us or visit our website for more information.



Large Wire Bonding Tools
A wide range of Large Wire Bonding tool solutions for Manual, Automatic, and Rotary Bonding Equipment. DeWeyl offers a minimum of three material choices for your consideration, Tungsten Carbide, Titanium and Ceramic.



The A8D Option
In addition to the ceramic tip wedges, DeWeyl has developed an exclusive design for the "vertical feed" applications identified as the "A8D" option. This feature maintains maximum control during the looping and feeding operation's of your equipment. It is highly recommended for maximum vertical feed/deep access performance.



Vietnam's leading supplier of semiconductor interconnect assembly equipment.

www.acrosemi.com

Email: sales@acrosemi.com

U.S.A Office

4930 W. Flight Ave.,
Santa Ana, California 92704, U.S.A.
Tel: 714-468-9034
Fax: 866-212-8857
Email: sales@acrosemi.com

Ho Chi Minh Office

404 Plot G, Tan Binh IZ, Tan Phu Dist.,
Ho Chi Minh City, Vietnam
Tel: (+84 8) 6 674-2919
Fax: (+84 8) 3 815-7077
Email: hcmc@acrosemi.com

Hanoi Office

1, Dai Co Viet Road,
Hanoi City, Vietnam
Tel: (+84) 91-225-7173
Fax: (+001) 866-212-8857
Email: hanoi@acrosemi.com